



Additional Information







Samples

Resources

Maximum Ratings and Thermal Characteristics $(T_a=25^{\circ}C \text{ unless otherwise noted})$

Parameter	Symbol	Value	Unit
Operating Storage Temperature Range	T _{STG}	-55 to 150	°C
Operating Junction Temperature Range	T _J	-55 to 125	°C
Current Rating ¹	I _{PP}	1	kA

Note:

1. Rated I_{pp} measured with 8/20µs pulse.

Description

The AK1 series of high power TVS diode is specially designed for meeting severe surge test environment of both AC and DC line protection applications. It features a very fast response and ultra low clamping characteristics over traditional metal oxide varistor (MOV) solutions. They can be connected in series and / or parallel to create a very high surge current protection solution.

Features

- Very low clamping voltage
- Ultra compact: less than onetenth the size of traditional discrete solutions
- Sharp breakdown voltage
- Low slope resistance
- Bi-directional
- IEC 61000-4-2 ESD 15kV(Air), 8kV (Contact)
- Symmetric in leads width for easier soldering during assembly.

- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Halogen-free
- RoHS compliant
- Glass passivated junction
- Pb-free E4 means 2nd level interconnect is Pb-free and the terminal finish material is Silver

Agency Approvals

Agency	Agency File/Certificate Number			
71 °	E128662			

Functional Diagram



Electrical Characteristics (T_A=25°C unless otherwise noted)

Part Numbers	Part Marking	Standoff Voltage (V _{so}) Volts	Max. Reverse Leakage (I _R) @V _{SO}	Typical I _R @ 85°C (µA)	Reverse Breakdown Voltage (V _{BR}) @ I _T		Test Current I _T	Voltage		Max. Temp Coefficient OF V _{BR}	Max. Capacitance 0 Bias 10kHz	Agency Approval
			μA		Min Volts	Max Volts	(mA)	V _{CL} Volts	I _{PP} Amps	(%/°C)	(nF)	
AK1 - 076C	1-076C	76	10	15	85	95	10	140	1.000	0.1	8.5	X

Note: Using 8/20µS wave shape as defined in IEC 61000-4-5.



AK1 Series Axial Leaded – 1kA

Physical Specifications

Weight	Contact manufacturer
Case	Epoxy encapsulated
Terminal	Silver plated leads, solderable per MIL-STD-750 Method 2026

Flow/Wave Soldering (Solder Dipping)

Peak Temperature :	265°C
Dipping Time :	10 seconds
Soldering :	1 time

Wave Solder Profile

Figure 1 -Non Lead-free Profile

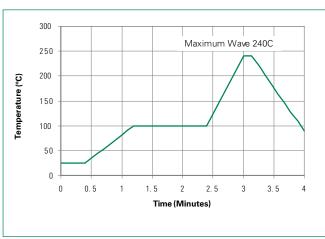
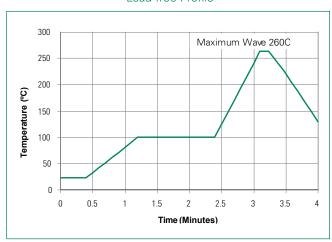


Figure 2 -Lead-free Profile



Ratings and Characteristic Curves (T_A=25°C unless otherwise noted)

Figure 3 Peak Power Derating

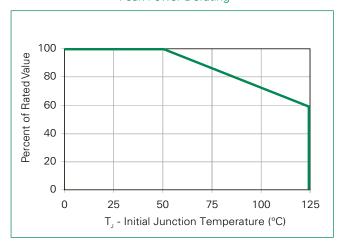
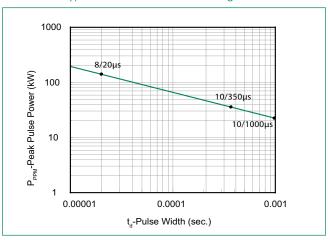


Figure 4 - Typical Peak Pulse Power Rating Curve



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Ratings and Characteristic Curves (T_A=25°C unless otherwise noted) (Continued)

Figure 5 - Typical VBR Vs Junction Temperature

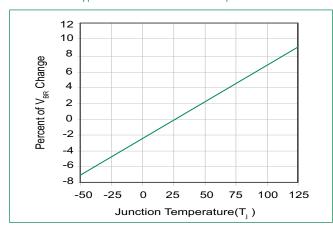
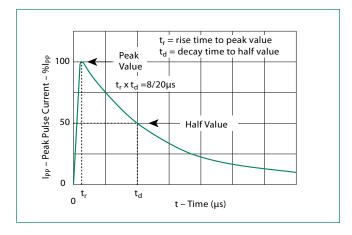
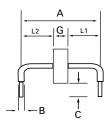
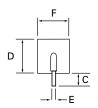


Figure 6 - Pulse Waveform



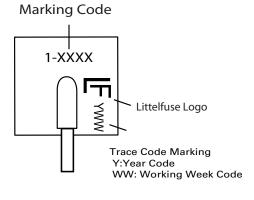
Dimensions





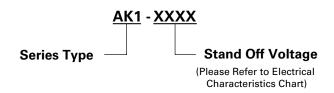
Dimensions	Inches	Millimeters			
Α	0.950 +/- 0.040	24.15 +/- 1.00			
В	B 0.095 +/- 0.024 2.4 +				
С	0.236 +/- 0.039	6.00 +/- 1.00			
D	0.570 max.	14.48 max.			
E	0.050 +/- 0.002	1.270 +/- 0.05			
F	0.500 max.	12.70 max.			
G	0.096 +/- 0.040	2.44 +/- 1.00			
L1/L2	L1= L2 tolerance +/- 0.04 inch (1.0 mm)				

Part Marking System



Side View

Part Numbering System



Packing Options

Part Number	Component Package	Quantity	Packaging Option
AK1-XXXX	AK Package	56pcs/Box	Bulk
AK1-XXXX-12	AK Package	12pcs/Box	Bulk

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